

FORM PTO-1449 (SUBSTITUTE)

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEAttorney Docket No.:
GR 98 P 4137 PApplic. No.
09/761,594INFORMATION DISCLOSURE
STATEMENT BY APPLICANT
(37 CFR 1.98(b))

Applicant

Hans-Jürgen Hacke et al.

Filing Date
January 16, 2001

Group Art Unit

1732

U.S. PATENT DOCUMENTS

EXAMINER INITIALS		PATENT NO.	DATE	PATENTEE	CLASS	SUB CLASS	FILING DATE
JH	A	5,340,775	08/23/94	Carruthers et al.	-	-	
JH	B	5,663,086	09/02/97	Rostoker et al.	-	-	
JH	C	5,672,542	09/30/97	Schwiebert et al.	-	-	
	D						
	E						
	F						
	G						
	H						
	I						

FOREIGN PATENT DOCUMENT

		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB CLASS	TRANSL. YES NO
	J						
	K						
	L						
	M						
	N						

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

JH	O	John R. Morris et al.: "Stencil Printing of Solder Paste for Fine-Pitch Surface Mount Assembly", <i>IEEE Transactions on Components, Hybrids, and Manufacturing Technology</i> , Vol. 14, September 1991, No. 3, pp. 560-566
JH	P	P. Van Zant: "Microchip Fabrication" Chapter 7, McGraw Hill, New York, 1998, pp. 139-146, 598-599

EXAMINER:

JH T. Hagan

DATE CONSIDERED

3/22/03

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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